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- Inputs Are TTL-Voltage Compatible
- *EPIC* <sup>™</sup> (Enhanced-Performance Implanted CMOS) 1-μm Process
- Package Options Include Plastic Small-Outline (D), Shrink Small-Outline (DB), and Thin Shrink Small-Outline (PW) Packages, Ceramic Chip Carriers (FK) and Flatpacks (W), and Standard Plastic (N) and Ceramic (J) DIPS

#### description

The 'ACT32 are quadruple 2-input positive-OR gates. The devices perform the Boolean function Y = A + B or  $Y = \overline{A} \bullet \overline{B}$  in positive logic.

The SN54ACT32 is characterized for operation over the full military temperature range of  $-55^{\circ}$ C to 125°C. The SN74ACT32 is characterized for operation from  $-40^{\circ}$ C to 85°C.

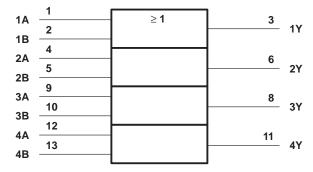
FUNCTION TABLE<br/>(EACH GATE)INPUTSOUTPUTABYHXHXHH

L

L

L

## logic symbol<sup>†</sup>



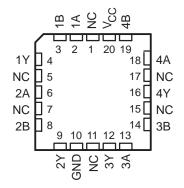
<sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for the D, DB, J, N, PW, and W packages.

#### SN54ACT32 . . . J OR W PACKAGE SN74ACT32 . . . D, DB, N, OR PW PACKAGE (TOP VIEW)

	•		
		$\overline{\mathbf{U}}$	L
1A	<b>[</b> 1	14	V <sub>CC</sub>
	2	13	] 4B
1Y	<b>[</b> 3	12	] 4A
2A	4	11	] V <sub>CC</sub> ] 4B ] 4A ] 4Y ] 3B
2B	5	10	] 3B
2Y GND	6	9	] 3A ] 3Y
GND	<b>[</b> 7	8	] 3Y

SN54ACT32 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

## logic diagram (positive logic)





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### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

Supply voltage range, $V_{CC}$ Input voltage range, $V_I$ (see Note 1) Output voltage range, $V_O$ (see Note 1) Input clamp current, $I_{IK}$ ( $V_I < 0$ or $V_I > V_{CC}$ ) Output clamp current, $I_{OK}$ ( $V_O < 0$ or $V_O > V_{CC}$ ) Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ ) Continuous current through $V_{CC}$ or GND Maximum power dissipation at $T_A = 55^{\circ}C$ (in still air) (see Note 2)	-0.5 V to V <sub>CC</sub> + 0.5 V -0.5 V to V <sub>CC</sub> + 0.5 V ±20 mA ±20 mA ±50 mA ±200 mA ): D package
	PW package 0.5 W
Storage temperature range, T <sub>stg</sub>	–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils, except for the N package, which has a trace length of zero.

#### recommended operating conditions (see Note 3)

		SN54ACT32		SN74A	UNIT	
		MIN MAX		MIN	MAX	UNIT
VCC	Supply voltage	4.5	5.5	4.5	5.5	V
VIH	High-level input voltage	2	W	2		V
VIL	Low-level input voltage		0.8		0.8	V
VI	Input voltage	0	Vcc	0	VCC	V
Vo	Output voltage	0	VCC	0	VCC	V
ЮН	High-level output current	ng	-24		-24	mA
IOL	Low-level output current	40	24		24	mA
$\Delta t/\Delta v$	Input transition rise or fall rate	<b>Q</b> 0	8	0	8	ns/V
Т <sub>А</sub>	Operating free-air temperature	-55	125	-40	85	°C

NOTE 3: Unused inputs must be held high or low to prevent them from floating.

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PARAMETER TEST CONDITIONS		Vcc	T <sub>A</sub> = 25°C			SN54ACT32		SN74ACT32		UNIT	
PARAMETER	TEST CONDITIONS		MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT	
Veri	I <sub>OH</sub> = -50 μA	4.5 V	4.4			4.4		4.4			
		5.5 V	5.4			5.4		5.4			
	$I_{OH} = -24 \text{ mA}$	4.5 V	3.86			3.7		3.76		V	
VOH	OH = -24 mA	5.5 V	4.86			4.7		4.76		v	
	$I_{OH} = -50 \text{ mA}^{\dagger}$	5.5 V				3.86					
	$I_{OH} = -75 \text{ mA}^{\dagger}$	5.5 V					EW	3.85			
	I <sub>OL</sub> = 50 μA	4.5 V		0.001	0.1		0.1		0.1		
		5.5 V		0.001	0.1		0.1		0.1		
Vo	I <sub>OL</sub> = 24 mA	5.5 V			0.36	Ċ)	0.5		0.44	v	
VOL		5.5 V			0.36	202	0.5		0.44		
	$I_{OL} = 50 \text{ mA}^{\dagger}$	5.5 V				A.	1.65				
	I <sub>OL</sub> = 75 mA <sup>†</sup>								1.65		
lj	$V_I = V_{CC}$ or GND	5.5 V			±0.1		±1		±1	μA	
ICC	$V_{I} = V_{CC} \text{ or } GND, \qquad I_{O} = 0$	5.5 V			2		40		20	μA	
$\Delta$ I <sub>CC</sub> ‡	One input at 3.4 V, Other inputs at $V_{CC}$ or GND	5.5 V		0.6			1.6		1.5	mA	
Ci	$V_{I} = V_{CC}$ or GND	5 V		2.6						pF	

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

<sup>†</sup> Not more than one output should be tested at a time, and the duration of the test should not exceed 2 ms.

<sup>‡</sup>This is the increase in supply current for each input that is at one of the specified TTL voltage levels rather than 0 V or V<sub>CC</sub>.

# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 5 V $\pm\,$ 0.5 V (unless otherwise noted) (see Figure 1)

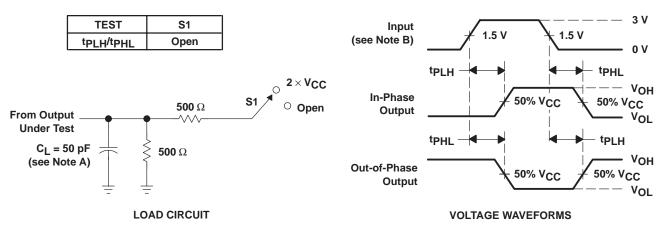
PARAMETER	FROM	TO (OUTPUT)	T <sub>A</sub> = 25°C			SN54ACT32	SN74ACT32		UNIT
PARAMETER	(INPUT)		MIN	TYP	MAX	MIN MAX	MIN	MAX	
<sup>t</sup> PLH	A or B	V	1	6.5	9	ROENT	1	10	
<sup>t</sup> PHL			1	6.5	9	64	1	10	ns

## operating characteristics, $V_{CC} = 5 V$ , $T_A = 25^{\circ}C$

PARAMETER		TEST CON	TYP	UNIT	
C <sub>pd</sub>	Power dissipation capacitance	C <sub>L</sub> = 50 pF,	f = 1 MHz	40	pF



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### PARAMETER MEASUREMENT INFORMATION

NOTES: A. CL includes probe and jig capacitance.

- B. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz, Z<sub>Q</sub> = 50  $\Omega$ , t<sub>f</sub>  $\leq$  2.5 ns. t<sub>f</sub>  $\leq$  2.5 ns.
- C. The outputs are measured one at a time with one input transition per measurement.

#### Figure 1. Load Circuit and Voltage Waveforms



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